

L-BAND SPDT SWITCH**DESCRIPTION**

The μ PG2012TB is a GaAs MMIC for L-band SPDT (Single Pole Double Throw) switch which were developed for mobile phone and another L-band application.

This device can operate frequency from 0.5 GHz to 2.5 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin super minimold package. And this package is able to high-density surface mounting.

FEATURES

- Supply voltage : $V_{DD} = 2.7$ to 3.0 V (2.8 V TYP.)
- Switch control voltage : $V_{cont(H)} = 2.7$ to 3.0 V (2.8 V TYP.)
: $V_{cont(L)} = -0.2$ to $+0.2$ V (0 V TYP.)
- Low insertion loss : $L_{INS1} = 0.27$ dB TYP. @ $f = 0.5$ to 1.0 GHz, $V_{DD} = 2.8$ V, $V_{cont} = 2.8$ V/0 V
: $L_{INS2} = 0.30$ dB TYP. @ $f = 2.0$ GHz, $V_{DD} = 2.8$ V, $V_{cont} = 2.8$ V/0 V
: $L_{INS3} = 0.30$ dB TYP. @ $f = 2.5$ GHz, $V_{DD} = 2.8$ V, $V_{cont} = 2.8$ V/0 V (Reference value)
- High isolation : $ISL1 = 28$ dB TYP. @ $f = 0.5$ to 2.0 GHz, $V_{DD} = 2.8$ V, $V_{cont} = 2.8$ V/0 V
: $ISL2 = 25$ dB TYP. @ $f = 2.5$ GHz, $V_{DD} = 2.8$ V, $V_{cont} = 2.8$ V/0 V (Reference value)
- High-density surface mounting : 6-pin super minimold package ($2.0 \times 1.25 \times 0.9$ mm)

APPLICATIONS

- L-band digital cellular or cordless telephone
- PCS, W-LAN, WLL and Bluetooth™ etc.

ORDERING INFORMATION

Part Number	Package	Marking	Supplying Form
μ PG2012TB-E3	6-pin super minimold	G3A	<ul style="list-style-type: none">• Embossed tape 8 mm wide• Pin 1, 2, 3 face the perforation side of the tape• Qty 3 kpcs/reel

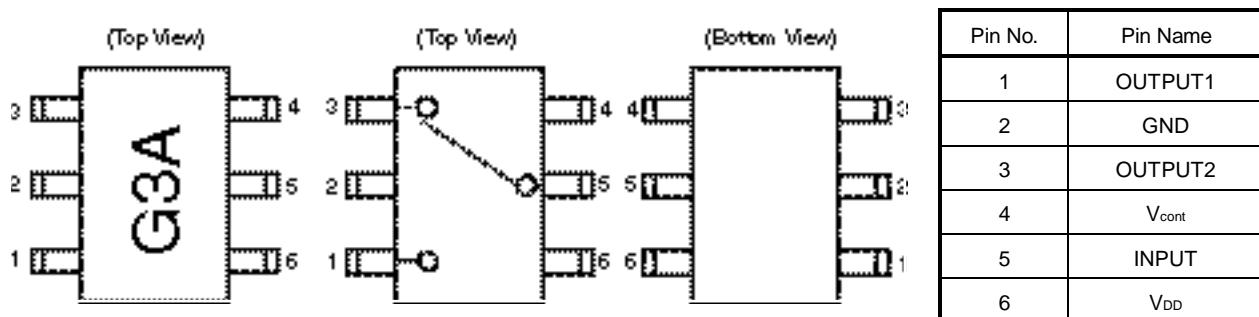
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μ PG2012TB-A

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



TRUTH TABLE

V_{cont}	INPUT-OUTPUT1	INPUT-OUTPUT2
Low	OFF	ON
High	ON	OFF

ABSOLUTE MAXIMUM RATINGS ($T_A = +25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V_{DD}	+6.0	V
Switch Control Voltage	V_{cont}	+6.0	V
Input Power	P_{in}	+26	dBm
Power Dissipation	P_D	150 <small>Note</small>	mW
Operating Ambient Temperature	T_A	-45 to +85	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB, $T_A = +85^\circ\text{C}$

RECOMMENDED OPERATING RANGE ($T_A = +25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V_{DD}	2.7	2.8	3.0	V
Switch Control Voltage (H)	$V_{cont(H)}$	2.7	2.8	3.0	V
Switch Control Voltage (L)	$V_{cont(L)}$	-0.2	0	0.2	V

ELECTRICAL CHARACTERISTICS

(TA = +25°C, VDD = 2.8 V, Vcont = 2.8 V/0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss1	LINS1	f = 0.5 to 1.0 GHz	–	0.27	0.50	dB
Insertion Loss2	LINS2	f = 2.0 GHz	–	0.30	0.50	dB
Isolation1	ISL1	f = 0.5 to 2.0 GHz	24	28	–	dB
Input Return Loss	RLin	f = 0.5 to 2.5 GHz	15	20	–	dB
Output Return Loss	Rfout	f = 0.5 to 2.5 GHz	15	20	–	dB
0.1 dB Gain Compression Input Power ^{Note}	P _{in(0.1 dB)}	f = 2.0 GHz	+17.5	+20.5	–	dBm
Supply Current	I _{DD}		–	50	100	μ A
Switching Control Current	I _{cont}		–	4	20	μ A

Note P_{in(0.1 dB)} is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

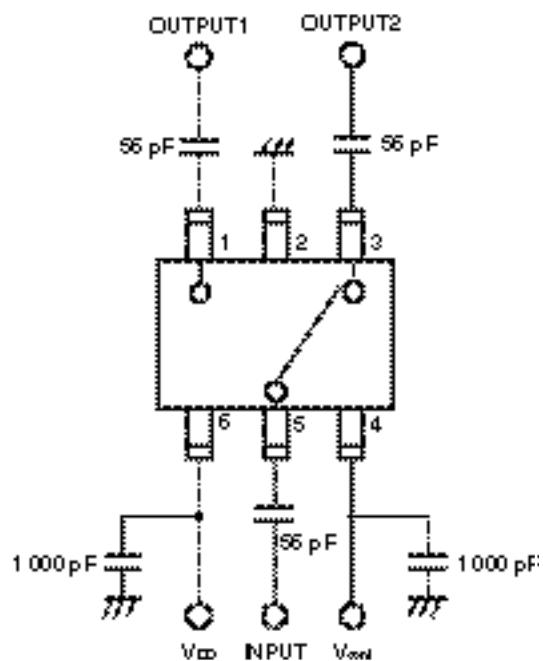
STANDARD CHARACTERISTICS FOR REFERENCE

(TA = +25°C, VDD = 2.8 V, Vcont = 2.8 V/0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss3	LINS3	f = 2.5 GHz	–	0.30	–	dB
Isolation2	ISL2	f = 2.5 GHz	–	25	–	dB
1 dB Gain Compression Input Power ^{Note}	P _{in(1 dB)}	f = 2.0 GHz	–	+24.0	–	dBm
Switching Control Speed	tsw		–	300	–	ns

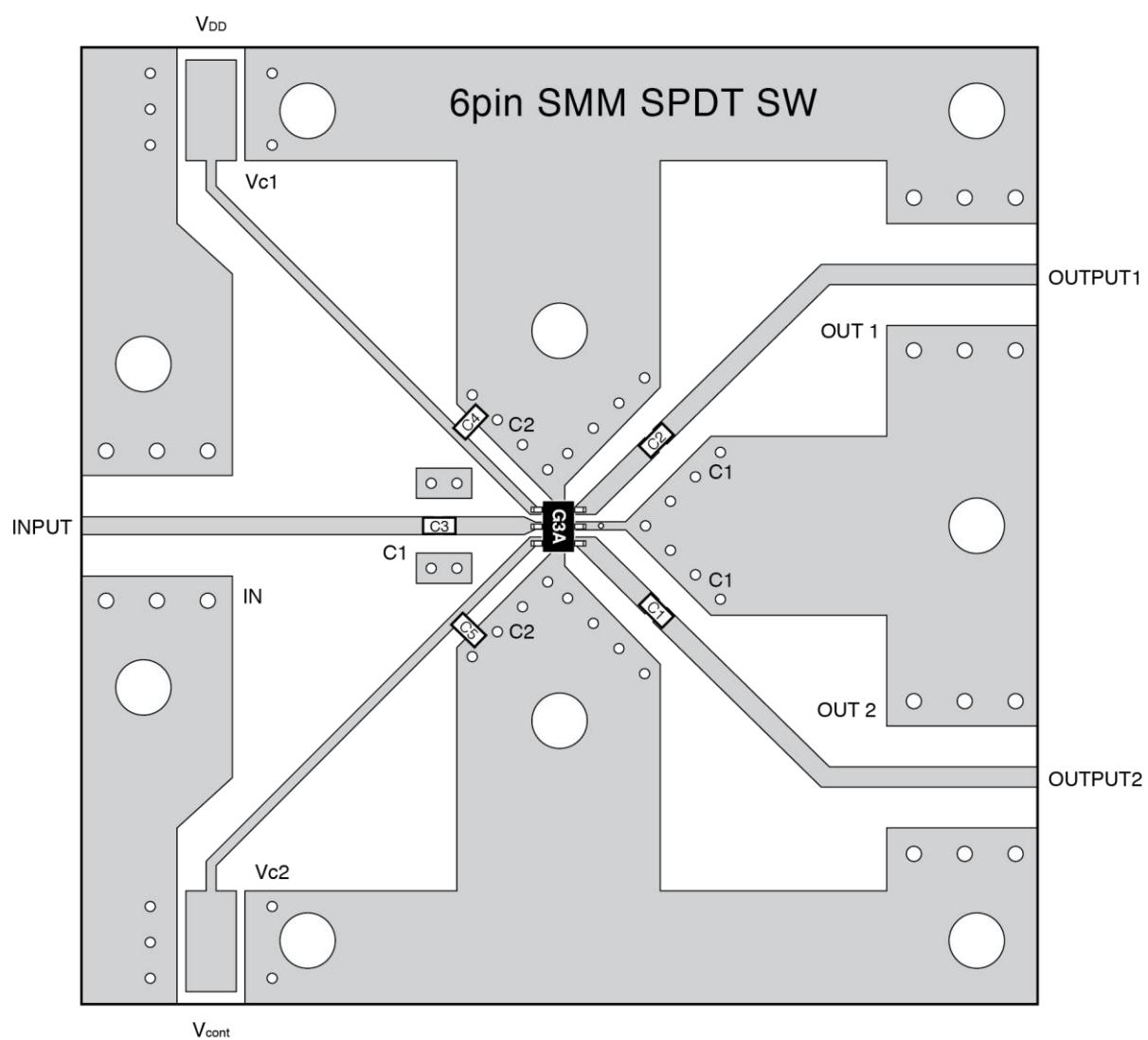
Note P_{in(1 dB)} is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors. The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

EVALUATION CIRCUIT ($V_{DD} = 2.8$ V, $V_{cont} = 2.8$ V/0 V, DC cut capacitors = 56 pF)

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

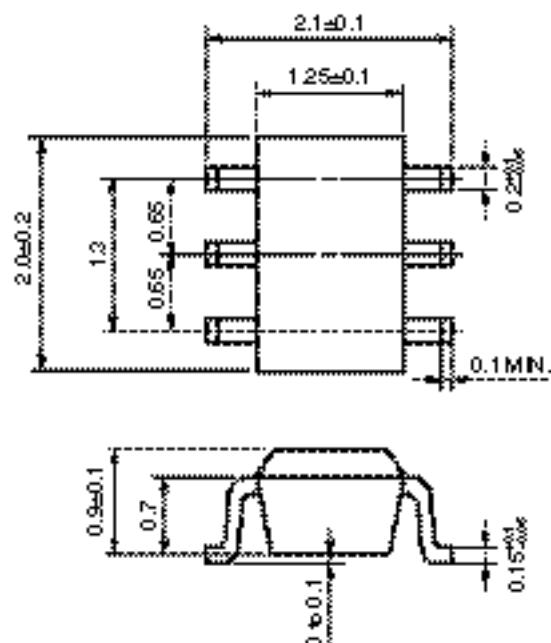


USING THE EVALUATION BOARD

Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
VPS	Peak temperature (package surface temperature)	: 215°C or below	VP215
	Time at temperature of 200°C or higher	: 25 to 40 seconds	
	Preheating time at 120 to 150°C	: 30 to 60 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Wave Soldering	Peak temperature (molten solder temperature)	: 260°C or below	WS260
	Time at peak temperature	: 10 seconds or less	
	Preheating temperature (package surface temperature)	: 120°C or below	
	Maximum number of flow processes	: 1 time	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (pin temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

Caution Do not use different soldering methods together (except for partial heating).

SAFETY INFORMATION ON THIS PRODUCT**Caution****GaAs Products**

The product contains gallium arsenide, GaAs.
GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- Do not destroy or burn the product.
- Do not cut or cleave off any part of the product.
- Do not crush or chemically dissolve the product.
- Do not put the product in the mouth.

Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

О компании

ООО "ТрейдЭлектроникс" - это оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов. Реализуемая нашей компанией продукция насчитывает более полумиллиона наименований.

Благодаря этому наша компания предлагает к поставке практически не ограниченный ассортимент компонентов как оптовыми, мелкооптовыми партиями, так и в розницу.

Наличие собственной эффективной системы логистики обеспечивает надежную поставку продукции по конкурентным ценам в точно указанные сроки.

Срок поставки со стоков в **Европе и Америке – от 3 до 14 дней.**

Срок поставки из **Азии – от 10 дней.**

Благодаря развитой сети поставщиков, помогаем в поиске и приобретении экзотичных или снятых с производства компонентов.

Предоставляем спец цены на элементы для создания инженерных сэмплов.

Упорный труд, качественный результат дают нам право быть уверенными в себе и надежными для наших клиентов.

Наша компания это:

- Гарантия качества поставляемой продукции
- Широкий ассортимент
- Минимальные сроки поставок
- Техническая поддержка
- Подбор комплектации
- Индивидуальный подход
- Гибкое ценообразование

Наша организация особенно сильна в поставках модулей, микросхем, пассивных компонентов, ксайленсах (ХС), EPF, EPM и силовой электроники.

Большой выбор предлагаемой продукции, различные виды оплаты и доставки, позволят Вам сэкономить время и получить максимум выгоды от сотрудничества с нами!

Перечень производителей, продукцию которых мы поставляем на российский рынок

AMD

ANALOG DEVICES

BOURNS

Coilcraft
The world's largest manufacturer of magnetic components

élan tec
Semiconductor, Inc.

HARRIS

infineon

JRC

MICREL
Innovation through Technology™

MOTOROLA

nichicon

PHILIPS

ROHM

ST SGS-THOMSON
Microelectronics

Sipex

TAIYO YUDEN

TOKO

ZILAS

Winbond
Electronics Corp.

Allegro
MicroSystems, Inc.

ATMEL

BURR - BROWN
BB

EXAR

HITACHI
Inspire the Next

intel

Lattice
Semiconductor Corporation

muRata
Leader in Electronics

OKI

QUALCOMM

SAMSUNG

SHARP

SONY

TDK

TOSHIBA

XORX

ALTERA

AVX
Components

CATALYST

CYPRESS
TECHNOLOGY

FAIRCHILD
SEMICONDUCTOR

HOLTEK

International IOR Rectifier

LINEAR TECHNOLOGY
mitsubishi

National Semiconductor

ON Semiconductor
UN

REALTEK
Radish Semiconductor Corp.

SANYO

SHINDENGEN

SS

TECCOR
ELECTRONICS

TUNDRA

XILINX

Amphenol

Bay Linear

CIRRUS LOGIC

DALLAS

FUJITSU

IDT

intersil

MAXIM

molex

NEC

Panasonic

RENESAS

SII
Silico Instruments Inc.

SIEMENS

ST

TEXAS INSTRUMENTS

VISHAY

ZETEX
SEMICONDUCTORS



гарантия бесперебойности производства и
качества выпускаемой продукции

С удовольствием будем прорабатывать для Вас поставки всех необходимых компонентов по текущим запросам для скорейшего выявления групп элементов, по которым сотрудничество именно с нашей компанией будет для Вас максимально выгодным!

С уважением,

Менеджер отдела продаж ООО

«Трейд Электроникс»

Шишлаков Евгений

8 (495)668-30-28 доб 169

manager28@tradeelectronics.ru

<http://www.tradeelectronics.ru/>